Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claims 1-7 (canceled).

Claim 8 (previously presented): An insulation coated conductive particle comprising a conductive particle having a surface that is coated with an insulating resin layer formed of an insulating resin having a carboxyl group, wherein the insulating resin layer is surface-treated with a polyfunctional aziridine compound.

Claim 9 (previously presented): The insulation coated conductive particle according to claim 8, wherein the insulating resin layer is composed of an insulating resin selected from the group consisting of an acrylic acid monomer unit and a methacrylic acid monomer unit.

Claim 10 (currently amended): The insulation coated conductive particle according to claim 8, wherein ~~The~~ the polyfunctional aziridine compound is trimethylolpropane-tri-β-aziridinylpropionate, tetramethylolmethane-tri-β-aziridinylpropionate, or N,N-hexamethylene-1,6-bis-1-aziridinecarboxamide.

Claim 11 (previously presented): The insulation coated conductive particle according to claim 10, wherein the insulating resin layer is composed of an insulating resin selected from the group consisting of an acrylic acid monomer unit and a methacrylic acid monomer unit.

Claim 12 (previously presented): The insulation coated conductive particle according to claim 11, wherein the insulating resin is an acrylic acid-styrene copolymer.

Claim 13 (withdrawn): A method for fabricating an insulation coated conductive particle, comprising:

performing a surface treatment with a polyfunctional aziridine compound on an insulating resin layer that is formed of an insulating resin having a carboxyl group; and coating a surface of a conductive particle.

Claim 14 (currently amended): An anisotropic conductive adhesive comprising an insulation coated conductive particle that is dispersed in an insulating adhesive, wherein the insulation coated conductive particle includes a conductive particle having a surface that is coated with an insulating resin layer formed of an insulating resin having a carboxyl group, and wherein the insulating resin layer is surface-treated with a polyfunctional azirdine compound.

Claim 15 (currently amended): The ~~insulation coated conductive particle~~anisotropic conductive adhesive according to claim 14, wherein the insulating resin layer is composed of an insulating resin selected from the group consisting of an acrylic acid monomer unit and a methacrylic acid monomer unit.

Claim 16 (currently amended): The ~~insulation coated conductive particle~~anisotropic conductive adhesive according to claim 14, wherein ~~The~~ the polyfunctional aziridine compound is trimethylolpropane-tri-β-aziridinylpropionate, tetramethylolmethane-tri-β-aziridinylpropionate, or N,N-hexamethylene-1,6-bis-1-aziridinecarboxamide.

Claim 17 (currently amended): The ~~insulation coated conductive particle~~anisotropic conductive adhesive according to claim 16, wherein the insulating resin layer is composed of an insulating resin selected from the group consisting of an acrylic acid monomer unit and a methacrylic acid monomer unit.

Claim 18 (currently amended): The ~~insulation coated conductive particle~~anisotropic conductive adhesive according to claim 17, wherein the insulating resin is an acrylic acid-styrene copolymer.

Claim 19 (previously presented): The anisotropic conductive adhesive according to claim 14, wherein the insulating adhesive contains an epoxy resin.

Claim 20 (new): The insulation coated conductive particle according to claim 8, wherein the polyfunctional aziridine compound has two or more aziridine groups.

Claim 21 (new): The insulation coated conductive particle according to claim 8, wherein the insulating resin layer completely covers the surface of the conductive particle.

Claim 22 (new): The anisotropic conductive adhesive according to claim 14, wherein the polyfunctional aziridine compound has two or more aziridine groups.

Claim 23 (new): The anisotropic conductive adhesive according to claim 14, wherein the insulating resin layer completely covers the surface of the conductive particle.